



UPDATE CHANGE NOTIFICATION # 20088

Generic Copy

Issue Date: 27-Jun-2013

TITLE: Update Final Notification of additional Test and Tape & Reel site for flip-chip DSN2 family from ON Semiconductor Seremban, Malaysia to existing external manufacturing site, JCAP, China.

PROPOSED FIRST SHIP DATE: Not applicable

AFFECTED CHANGE CATEGORY(S): Not applicable

ADDITIONAL RELIABILITY DATA: Not applicable

SAMPLES: Not applicable

FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local ON Semiconductor Sales Office or FY Chan <FoongYing.Chan@onsemi.com>

NOTIFICATION TYPE: Update notification

DESCRIPTION AND PURPOSE:

Update of earlier announced FPCN#20088 to notify the customers that this change "Additional Test and Tape & Reel site for flip chip DSN2 family from ON Semiconductor Seremban, Malaysia to existing external manufacturing site, JCAP China" will not applied to NSR20F20NXT5G.

Part NSR20F20NXT5G has been removed from the affected part list for the change that was announced in FPCN#20088.

List of affected General Parts:

NSR20F20NXT5G